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SUMMARY

Wires

Low voltage 2



Image is for illustrative purpose only

Series 1B

Termination type Female print PCB

IP rating 50

AWG wire size 28.00 - 20.00 Cable Ø 0.00 - 0.00 mm

Status active

Matching parts FGG.1B.302.CLAD42Z

Download

Request a quote
PCB Eagle Pattern
PCB Altium Pattern
PCB KiCad Pattern

Catalog

TECHNICAL DETAILS

Mechanics

Shell Style/Model EY*: Fixed receptacle for printed circuit, nut fixing (back panel mounting)

Keying 1 key (alpha=0, plug: male contacts, receptacle: female contacts)

Housing Material

Brass (chrome plated [SAE AMS 2460]) shell and collet nut, nickel plated [SAE AMS QQ N 290]

brass latch sleeve and mid pieces

Weight 12.18 g

Performance

Configuration 1B.302 : 2 Low Voltage Insulator L: PEEK (UL 94 / V-0/1.5)

Rated Current 15 Amps

Specifications

Contact Type: Print (straight)
Contact Dia.: 1.3 mm (0.051in)

R (max): 3.6 mOhm

Vtest (contact-shell): 1350 V (AC), 1910 V (DC) Vtest (contact-contact): 1500 V (AC), 2120 V (DC)

Others

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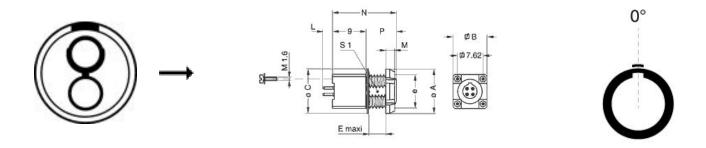
Endurance (Shell): 5000

Temp (min / max): -55°C / +250°C

Humidity (max): <=95% [at 60 deg C /140 F]

Vibration: 15 g [10 Hz - 2000 Hz] Shock Resistance: 100 g [6 ms] Climatical Category: 50/175/21 Shielding (min): 75 dB (10 MHz) Shielding (min): 40 dB (1 GHz) Salt Spray Corrosion: >1000 hr

DRAWINGS



Dimensions

	А	В	С	D	Е	М	N	Р	e
mm.	14	12	16	7.62	5	3.5	19	10	M11x0.5
in.	0,55	0,47	0,63	0,30	0,20	0,14	0,75	0,39	

RECOMMENDED BY LEMO

Tools

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